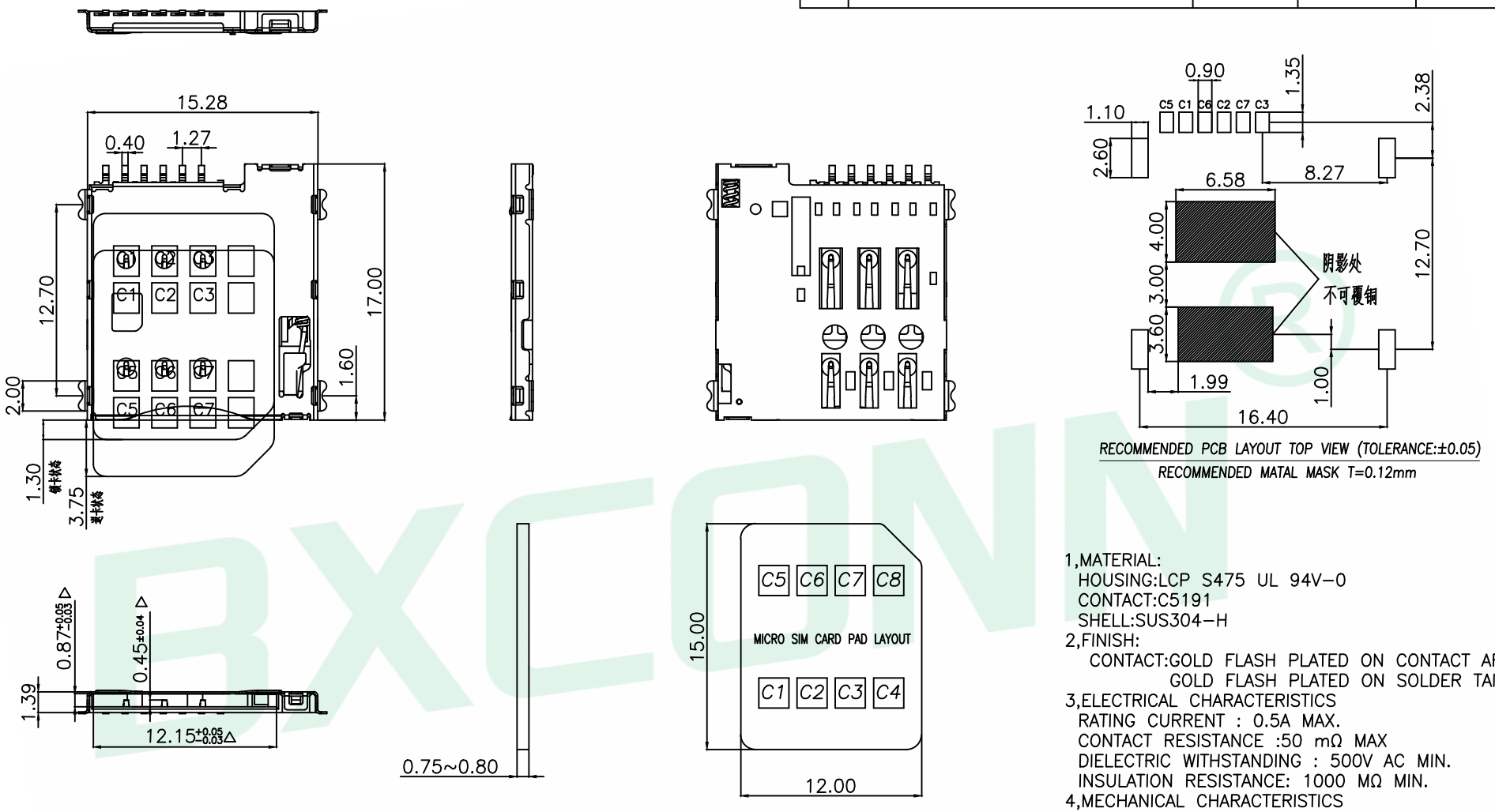
REV.	DESCRIPTION	ECN NO.	NAME	DATE



RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE:±0.05)

RECOMMENDED MATAL MASK T=0.12mm

SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

1,MATERIAL:
HOUSING:LCP S475 UL 94V-0
CONTACT:C5191
SHELL:SUS304-H
2,FINISH:
CONTACT:GOLD FLASH PLATED ON CONTACT AREA;
GOLD FLASH PLATED ON SOLDER TAILS,
3,ELECTRICAL CHARACTERISTICS
RATING CURRENT : 0.5A MAX.
CONTACT RESISTANCE :50 mΩ MAX
DIELECTRIC WITHSTANDING : 500V AC MIN.
INSULATION RESISTANCE: 1000 MΩ MIN.
4,MECHANICAL CHARACTERISTICS
MATING CYCLE :3000 CYCLES

GENERAL TOLERANCE		DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD		BXCONN®
DIM.	TOL.	TITLE: 1.35H 6PIN PUSH PUSH MICRO SIM CARD		
x.x	±0.35			
x.xx	±0.25			
x.xxx	±0.15			
GENERAL ANGLE:		DWG. NO.: SIM203-TZ6P	CHECKED: MAX	
x.°	±5°			
x.x°	±3°	PART NO.: SIM203-TZ6P	DRAWN: ELLA	
x.xx°	±1°			
		UNIT: mm / SCALE: none / SHEET: 1 of 1 / DWG. SIZE: A4 / LAYER: bxconn	APPROVED: WILL	

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